

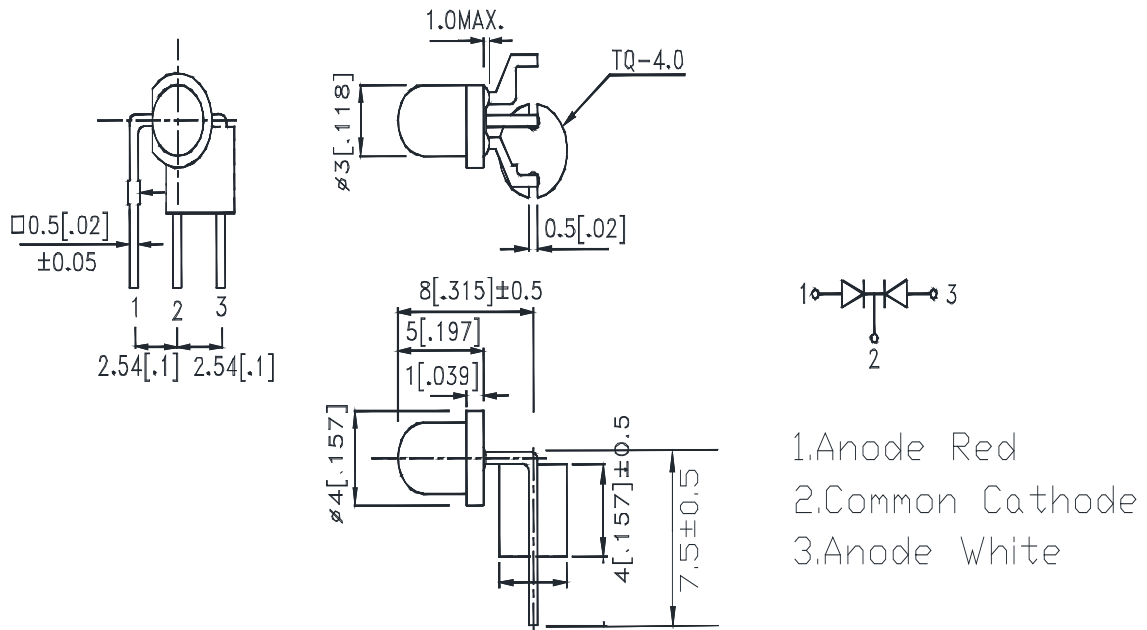
**Features**

- 3mm DIA LED Lamp
- Low Power Consumption
- High Efficiency
- Various Colors and Viewing Angle
- Long Solid State Reliability
- Package: 1000pcs/Packing

**Applications**

- Indicator

**Package Dimensions**



**Notes:**

1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25mm(.01") unless otherwise noted.
3. Protruded Resin under flange is 1.0mm(0.04") max.
4. Specifications are subject to change without notice.



**Selection Guide**

Part No	Lens Type	Dice	Emitted Color
FDA-3523RW-ZWD1-CC-L8.0-7.5	Diffused	InGaN AlInGaP	White Red

**Electrical / Optical Characteristics At Ta=25 °C**

Symbol	Parameter		Red	White	Unit	Test Condition
Iv	Luminous Intensity	MIN.	25	72	mcd	IF=20mA
		TYP.	125	380		
2θ1/2	Viewing Angle	TYP.	30	30	deg	IF=20mA
λ Peak(x)	Peak Emission Wavelength	TYP.	615	0.28	nm	IF=20mA
λ d(y)	Dominant Wavelength	TYP.	621	0.26	nm	IF=20mA
Δλ	Spectral Line Half-Width	TYP.	17	20	nm	IF=20mA
VF	Forward Voltage	MIN.	1.7	2.7	V	IF=20mA
		TYP.	2.3	3.1		

Note:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value
2. The chromaticity coordinates(x,y) is derived form 1931 CIE chromaticity diagram.
3. The chromaticity coordinates(x,y) guarantee should be added±0.02 tolerance.

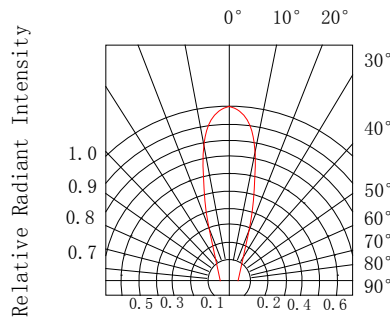
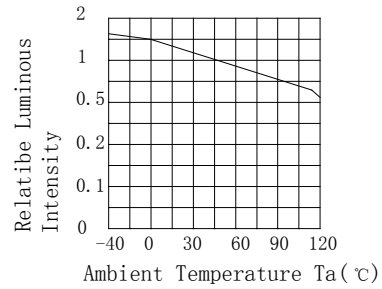
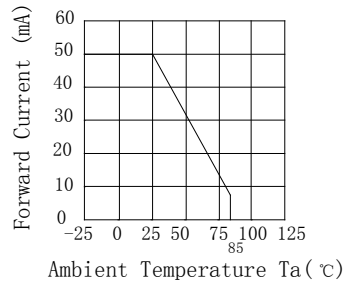
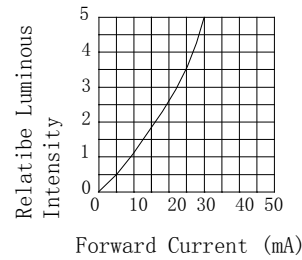
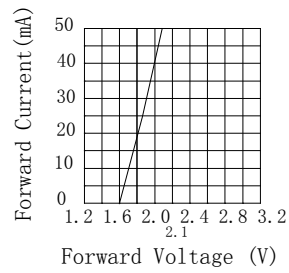
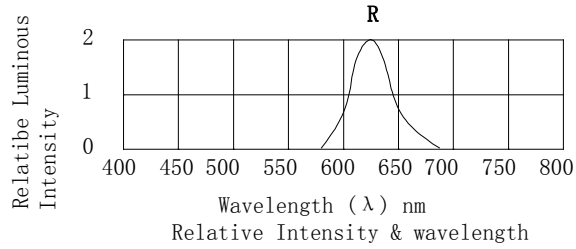
**Absolute Maximum Ratings At Ta=25°C**

Parameter	Red	White	Unit
Power Dissipation	75	95	mW
Peak Forward Current[1]	80	100	mA
Continuous Forward Current	25	25	mA
Derating Linear From 25°C	0.4	0.25	mA/°C
Reverse Voltage	5	5	V
Electrostatic Discharge Threshold(HBM)	2000	300	V
Operating Temperature Range	-55°C to + 85°C		
Storage Temperature Range	-55°C to + 85°C		
Soldering Condition	260°C For 5 Seconds		

Note:

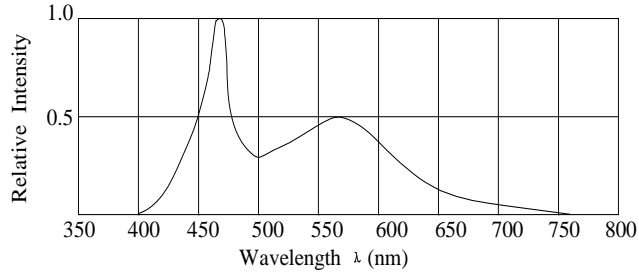
1. 1/10DutyCycle, 0.1msPulseWidth

**Electrical Optical Characteristics Curves At Ta=25 °C**

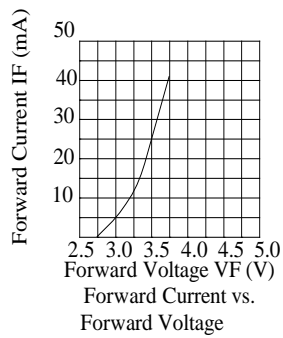


Radiation Diagram

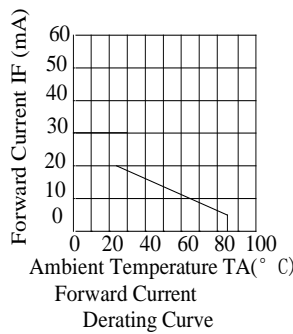
**Electrical Optical Characteristics Curves At Ta=25 °C**



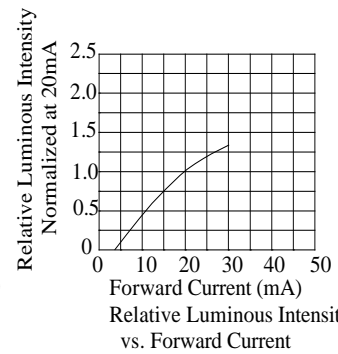
Relative Intensity VS. Wavelength



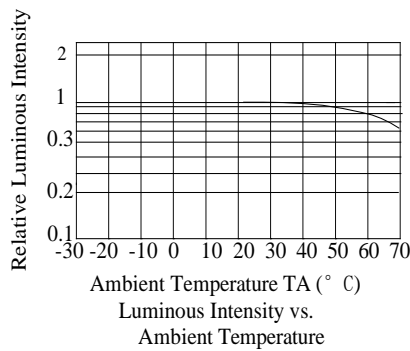
Forward Current vs. Forward Voltage



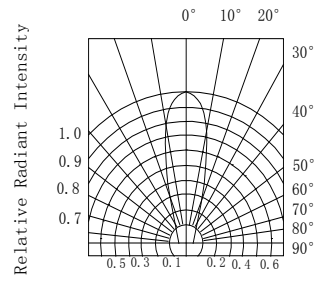
Derating Curve



Relative Luminous Intensity vs. Forward Current

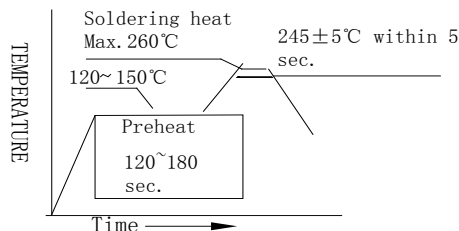


Luminous Intensity vs. Ambient Temperature



Radiation Diagram

**Reflow Soldering Instructions**



Notes:

1. The LEDs should be used within a year.
2. The LEDs should be kept in 5~30°C and 60% RH for less.
3. The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.



**Bin Range Of Luminous Intensity (+/-20%)**

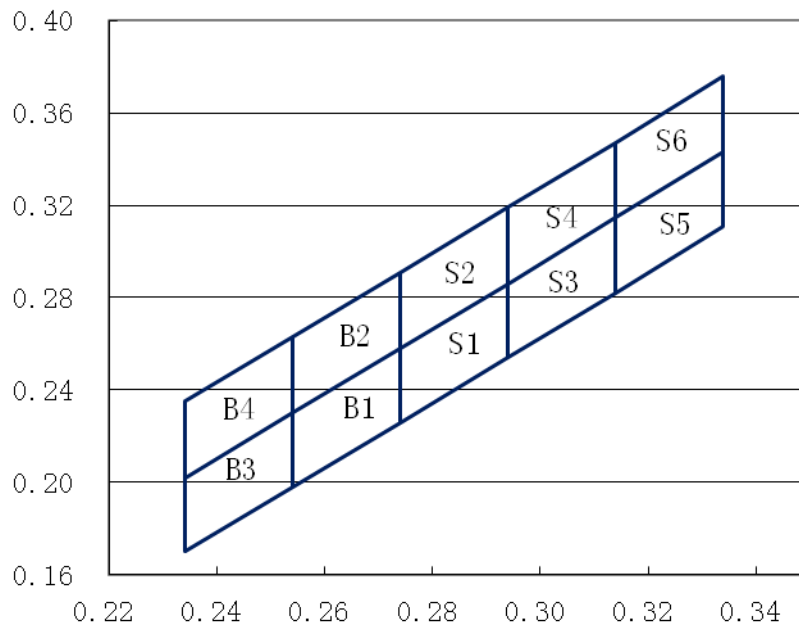
Symbol	Bin Code	Min.	Max.	Unit	Condition
I <sub>v</sub> (R)	N	28	45	mcd	IF=20mA
	P	45	72		
	Q	72	112		
	R	112	180		
I <sub>v</sub> (W)	Q	72	112	mcd	IF=20mA
	R	112	180		
	S	180	280		
	T	280	450		

**Chromaticity Coordinates Specifications for Bin Grading (+/-0.02)**

IF=20mA

BIN	X	Y	X	Y	X	Y	X	Y
B1	0.254	0.198	0.254	0.23	0.274	0.258	0.254	0.198
B2	0.254	0.23	0.254	0.263	0.274	0.291	0.274	0.258
B3	0.234	0.17	0.234	0.202	0.254	0.23	0.254	0.198
B4	0.234	0.202	0.234	0.235	0.254	0.263	0.254	0.23
S1	0.274	0.226	0.274	0.258	0.294	0.286	0.294	0.254
S2	0.274	0.258	0.274	0.291	0.294	0.319	0.294	0.286
S3	0.294	0.254	0.294	0.286	0.314	0.315	0.314	0.282
S4	0.294	0.286	0.294	0.319	0.314	0.347	0.314	0.315
S5	0.314	0.282	0.314	0.315	0.334	0.343	0.334	0.311
S6	0.314	0.315	0.314	0.347	0.334	0.376	0.334	0.343

**CIE Chromaticity Diagram (+/-0.02)**



**Reliability Test Items Conditions**

Classification	Test Item	Test Conditions	Test hours	Result
Endurance Test	Operation Life	Connect with a power $I_f=20\text{mA}$ $T_a$ =Under room temperature	1000Hrs	0/20
	High Temperature High Humidity	$T_a=+65^\circ\text{C}\pm 5^\circ\text{C}$ RH=90%-95%	240Hrs	0/20
	High Temperature Storage	High $T_a=+85^\circ\text{C}\pm 5^\circ\text{C}$	1000Hrs	0/20
	Low Temperature Storage	Low $T_a=-35^\circ\text{C}\pm 5^\circ\text{C}$ Test time=1000hrs	1000Hrs	0/20
Environmental Test	Temperature Cycling	$-45^\circ\text{C} \sim +105^\circ\text{C}$ 15min 5min 15min	300 Cycles	0/20
	Thermal Shock	$-35^\circ\text{C} \sim \pm 5^\circ\text{C} \sim +85^\circ\text{C} \sim \pm 5^\circ\text{C}$ 5min 10sec 5min	300 Cycles	0/20
	Solder Resistance	Preheating: $120^\circ\text{C}-150^\circ\text{C}$ , within 2 minutes. Operation heating : $260^\circ\text{C}$ (Max.), within 5 seconds (Max.)	5Cycles	0/20

**Judgment criteria of failure for the reliability**

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	$V_F(\text{V})$	$I_F=20\text{mA}$	Over $U \times 1.2$
Reverse current	$I_R(\mu\text{A})$	$V_R=5\text{V}$	Over $U \times 2$
Luminous intensity	$I_v(\text{mcd})$	$I_F=20\text{mA}$	Below $S \times 0.5$

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Measurement shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.